

HSDPA

Intel® XMM™ 6130

Low-Cost 3G Solution for Mobile Internet Browsing and Messaging

The Intel® XMM™ 6130 platform combines Intel's 2G/3G digital and analog baseband solution, Intel X-GOLD™ 613, with an Intel SMARTi™ UEmicro RF transceiver.

This cost-optimized HSDPA solution comes with a reference design on a 6-layer PCB as well as the world-proven Release 6 dual-mode protocol stack and a common software API layer (UTA), which enables 2G customers to easily migrate to 3G.

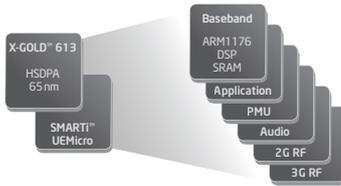
Intel XMM™ 6130 brings HSDPA modem capabilities to Web 2.0 applications and an enhanced Internet experience to the mass market.

Key Features

- HSPA 3.6/1.4
- 3 MPixel camera, integrated ISP
- HVGA display, QVGA video
- USB 2.0 with integrated PHY
- 6-layer PCB
- Dual SIM dual standby, hot swap

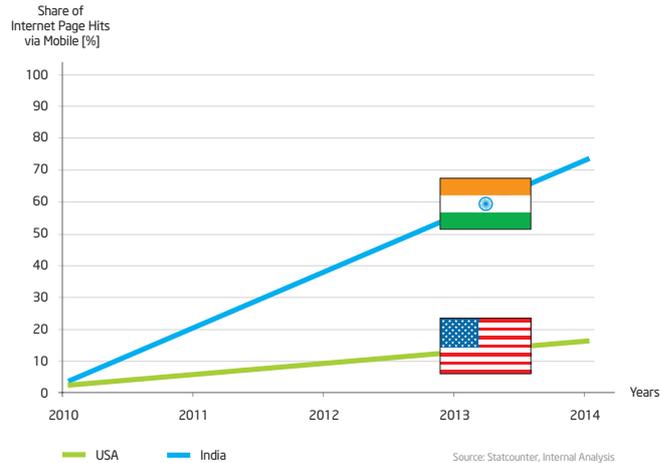
Key Benefits

- Operator-proven dual-mode stack
- Smooth user interface (UI)
- Very low Bill-of-Material (BOM)



Great Broadband Experience

Mobile phones are primary Internet access devices, especially in countries with limited wireline infrastructures. Intel XMM™ 6130 delivers broadband and a great browsing experience at exceptionally low prices.



For more information on Intel® XMM™ 6130, visit www.intel.com/go/mobilecommunications

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